



# CPES@DC

2023 CPES Annual Conference Special Event

**April 1<sup>st</sup> - 2<sup>nd</sup>, 2023**

Virginia Tech Research Center  
Arlington, VA

**Program of the 2<sup>nd</sup>  
Three Corners Power Electronics  
Extended Collaboration  
(3C-PEEC) Workshop**

*Moving Towards a Carbon-Free  
World by 2050*

*Online Program and Background:*



[cpesdc.cpes.vt.edu](http://cpesdc.cpes.vt.edu)



### Room Wifi:

- Network: VT-EBC
- Password: Hokies2023

### Zoom information for screen sharing:

- Meeting ID: 824 7194 3759
- Passcode: 12345

### Don't have Zoom?

#### Download:

<https://zoom.us/DOWNLOAD>

### Audience: Participate in Discussion

#### Press-to-Speak !

**Red light** indicates  
microphone is on

#### Questions? Issues?

Raise hand and the  
staff will assist you.

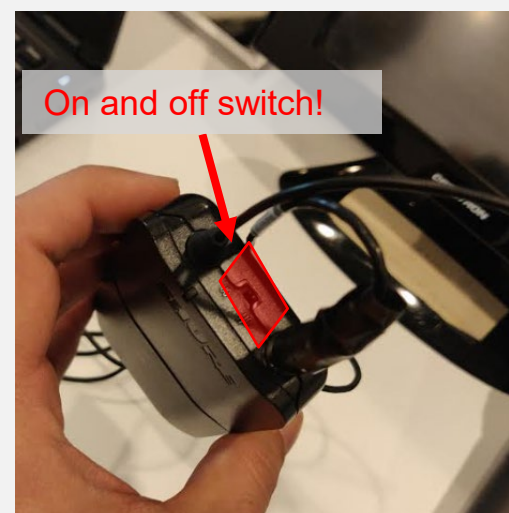


### Presenter: Positioning Statements

Lavalier Microphone will have  
on-and-off switch on top.

#### Questions? Issues?

Raise hand and the staff will assist  
you.



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## 2<sup>nd</sup> 3C-PEEC Workshop

### General Co-Chairs:

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**Hiromichi Ohashi**  
NPERC-J

**Leo Lorenz**  
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## 2<sup>nd</sup> 3C-PEEC Workshop

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## 2<sup>nd</sup> 3C-PEEC Workshop

### Organizing Chair:

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## 2<sup>nd</sup> 3C-PEEC Workshop

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## CPES@DC General Chair:

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## 2023 CPES Annual Conference General Chair:

**Narayan Rajagopal**  
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## CPES Director:

**Rolando Burgos**  
CPES-VT  
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## ***Welcome From CPES Director***

### ***Rolando Burgos***

It is my distinct pleasure to welcome you to the 2nd Three-Corners Power Electronics Extended Collaboration (3-C PEEC) Workshop, a Special Event to be conducted on April 1–2 at the CPES laboratories in Arlington, VA, in conjunction with the 2023 CPES Annual Conference.

This year, over 450 in-person and online participants from over 20 countries and 25 states will join the 41st CPES Annual Conference. This year marks the conference's expansion into the greater Washington DC metro area, highlighting CPES' unique position as a global leader in power electronics. The 3-C PEEC Workshop this year focuses on "Moving Towards a Carbon-Free World by 2050," where CPES, together with the European Center for Power Electronics (ECPE) and the New Generation of Power Electronics and System Research Consortium – Japan (NPERC-J), will immerse itself into a brainstorm session to explore what could be the global electrical energy system infrastructure necessary to power our planet.

The workshop will have over 12 position statements from experts in academia, industry, and government, 6 breakout sessions to plan and roadmap towards a carbon-free world, and two plenary sessions to discuss the role of power electronics in saving the world. Participants will also be able to tour the CPES laboratories in Arlington, VA, and participate in a student dialogue session. I would like to express my utmost gratitude to the outstanding organizing team, faculty, and students who helped organize this special event, but especially to the initiative and leadership of Fred Lee and Dushan Boroyevich, who firmly established the partnership with ECPE and NPERC-J nearly 10 years ago.

I would like to welcome you to the CPES and 3C-PEEC Workshop and wish you a productive and pleasant stay in Northern Virginia!

Yours sincerely,  
Rolando Burgos  
Professor, Director  
Center for Power Electronics Systems (CPES)



Around the beginning of this millennium, visionary leaders in power electronics from academia, industry and governments from around the world started to realize that provisioning of energy to humanity is going to be increasingly dependent on new pervasive technologies for electronic processing of electricity, and that the necessary innovations could only be achieved through global cooperation. That vision led to the formation of three major university-industry-government research partnerships: Center for Power Electronics Systems (CPES) in United states, Power Electronics Research Center (PERC) in Japan, and European Center for Power Electronics (ECPE) in Europe. These centers started information exchanges from the beginning, and have been developing different forms of continuing collaboration for over two decades now.



In 2015, a new Memorandum of Understanding was agreed between the New Generation of Power Electronics and System Research Consortium – Japan (NPERC-J; the successor to PERC), ECPE and CPES. It stipulated that the focal activity for the continuing open collaboration between the three organizations will be an annual meeting with two concentrations:

1. Broad exchange about ongoing research activities in the 3 communities,
2. Sharing and coordinating research and technology roadmaps.

After several informal gatherings and workshops, the first “*Three Corners Power Electronics Extended Collaboration*” (3C-PEEC) Workshop was held on January 28-29, 2020 in Tokyo, in conjunction with the 2<sup>nd</sup> New-generation Power Electronics Symposium (NPES), organized by NPERC-J.

Following the COVID-19-induced 2-year hiatus, the **2<sup>nd</sup> 3C-PEEC Workshop** is being held on April 1-2, 2023 in Washington, DC, in conjunction with the CPES 2023 Annual Conference.

**Saturday, April 1, 7:30 AM to 9 PM**

Time	Topic	Lead / Present
07:30 – 07:55	<i>Refreshments and Check-in</i>	<i>all</i>
<b>08:00 – 09:00</b>	<b>Plenary 1: Workshop Opening</b>	Chair: <b>Dushan Boroyevich</b> <i>Notetaker: Benjamin Lyon</i>
08:00 – 08:10	Welcome to Virginia Tech	Dan Sui
08:10 – 08:20	Welcome to Center for Power Electronics Systems (CPES)	Rolando Burgos
08:20 – 08:30	Expansion of CPES in Washington, DC Metropolitan Area	Christina DiMarino
08:30 – 08:40	Opening Remarks and Welcome from NPERC-J	Hiromichi Ohashi
08:40 – 08:50	Opening Remarks and Welcome from ECPE	Leo Lorenz
08:50 – 09:00	Workshop Goals and Organization	Dushan Boroyevich
<b>09:00 – 10:00</b>	<b>Plenary 2a: Positioning Statements I</b>	Chair: <b>Mohamed Belkhat</b> Co-Chair: <b>Dong Dong</b> <i>Notetaker: Benjamin Lyon</i>
09:00 – 09:15	Much More Electrification toward Full Carbon Neutral 2050	Hiromichi Ohashi
09:15 – 09:30	Digital Transformation of Power Electronics Towards Carbon-Free World in 2050	Makoto Takamiya
09:30 – 09:45	Answers to the "Homework Assignment"	Hirofumi Akagi
09:45 – 10:00	The Role of Power Electronics and the Quest for a Plug-and-Play Grid Organizing Framework	Jinjun Liu
10:00 – 10:15	<i>Break</i>	<i>all</i>
<b>10:15 – 12:00</b>	<b>Plenary 2b: Positioning Statements II (continued)</b>	Chair: <b>Tamara Baksht</b> Co-Chair: <b>Yuhao Zhang</b> <i>Notetaker: Haris Bin Ashraf</i>
10:15 – 10:30	ECPE: Facilitating the European Green Deal	Leo Lorenz
10:30 – 10:45	Power System of the Future	Pavol Bauer
10:45 – 11:00	Three Hints to Process Less & Better the Electrical Energy	José Cobos
11:00 – 11:15	Power Electronics Enabling a Net-Zero-CO <sub>2</sub> Integrated Multi-Carrier Energy System	Johann Kolar
11:15 – 11:30	A Few Challenges to Integrate 100% Renewable Sources in the Electrical Infrastructure	Paolo Mattavelli
11:30 – 11:45	Germany's Plans to Decarbonize the Energy System by 2045 Seen in a Global Context	Soenke Rogalla
11:45 – 12:00	Power Electronics – The Key Enabler for the Energy Transition	Rik de Doncker (online)
12:00 – 13:00	<i>Lunch</i> Welcome and “How Many Corners?”	<i>all</i> Fred Lee
<b>13:00 – 14:00</b>	<b>Plenary 2c: Positioning Statements III (continued)</b>	Chair: <b>Vlado Blasko</b> Co-Chair: <b>Rudy Wang</b> <i>Notetaker: Marie Lawson</i>
13:00 – 13:15	Intergrid for Sustainable Energy Abundance	Igor Cvetkovic
13:15 – 13:30	Democratization of Energy – Pathway to Sustainable Energy in 2050	Deepak Divan
13:30 – 13:45	Electrified Green Infrastructure Power Conversion	Richard Zhang
13:45 – 14:00	What is quality of life in 2050?	Shiori Idaka
<b>14:00 – 15:00</b>	<b>Plenary 3: Discussion of the Positioning Statements on Global Electrification by 2050</b>	Chair: <b>Vlado Blasko</b> Co-Chair: <b>Rudy Wang</b> <i>Notetaker: Marie Lawson</i>

Time	Topic	Lead / Present
15:00 – 15:15	<i>Break</i>	<i>all</i>
<b>15:15 – 17:00</b>	<b>Breakouts 1:</b> <b>2050 Global Electrical Energy System Infrastructure Components</b>	
Room: West Falls Church	Sustainable Generation of Electrical Energy and related System Architectures	Chair: <b>Kan Akatsu</b> Co-Chair: <b>Christina DiMarino</b> <i>Notetaker: Shivani Nair</i>
Room: Ballston	Transportation and Storage of Electrical Energy and related System Architectures	Chair: <b>Alan Mantooth</b> Co-Chair: <b>Dong Dong</b> <i>Notetaker: Taha Moaz</i>
Room: East Falls Church	Efficient Consumption of Electrical Energy and related System Architectures	Chair: <b>Zdenek Peroutka</b> Co-Chair: <b>Boran Fan</b> <i>Notetaker: Qian Li</i>
<b>17:30 – 21:00</b>	<b><i>Reception and Dinner at SER Restaurant</i></b>	<b><i>all</i></b>

**Sunday, April 2, 2023, 7:30 AM to 2 PM**

Time	Topic	Lead / Present	
07:30 – 07:55	Refreshments	all	
08:00 – 08:55	Plenary 4: Reporting from Breakouts and Selecting Three Global Electrical Energy System Architectures	Stephanie Butler Richard Zhang	
09:00 – 11:30	Breakouts 2: Back-Casting to Necessary Power Electronics Technology Advances		
	Breakout Group Orange Chair: Isik Kizilyalli Co-Chair: Igor Cvetkovic Room: Ballston	Breakout Group Yellow Chair: Keiji Wada Co-Chair: Rolando Burgos Room: West Falls Church	
	Breakout Group Cyan Chair: Peter Barbosa Co-Chair: Yuhao Zhang Room: East Falls Church		
09:00 – 09:45	Lab Dialogue with CPES Students 4 <sup>th</sup> Floor Lab	Architecture #2 of Global Electrical Energy Infrastructure	
		Architecture #3 of Global Electrical Energy Infrastructure	
09:45 – 10:00	Break		
10:00 – 10:15	Tour of CPES 5 <sup>th</sup> Floor Lab	Lab Dialogue with CPES Students 4 <sup>th</sup> Floor Lab	
10:15 – 10:30	Architecture #1 of Global Electrical Energy Infrastructure		
10:30 – 10:45		Tour of CPES 5 <sup>th</sup> Floor Lab	
10:45 – 11:00			Continue discussions on Architecture #2
11:00 – 11:15			
11:15 – 11:30			
11:30 – 12:00	Plenary 5: Reporting from Breakouts and Way Forward	Dushan Boroyevich	
12:00 – 13:00	Lunch and Closing Remarks	all Chair: Thomas Harder Hiromichi Ohashi Leo Lorenz	

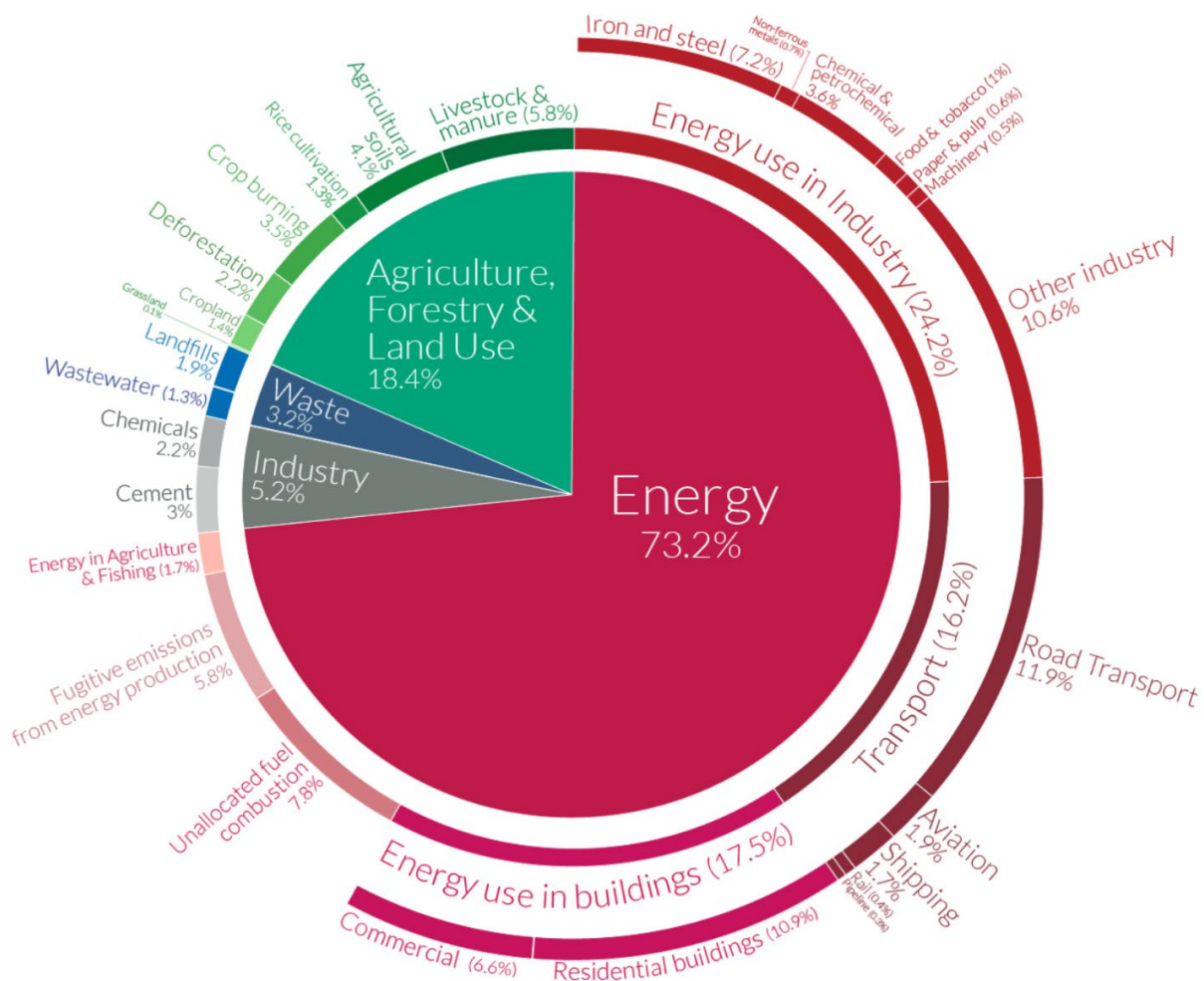
<b>14:00 – 18:00</b>	<i>Transfer by bus to Blacksburg for the participants in the CPES 2023 Annual Conference</i>
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## Workshop Goals and Methodology

At the 26<sup>th</sup> United Nations Climate Change Conference in 2021, leaders of the world agreed to reduce human emissions of greenhouse gasses to net-zero by 2050. Now, during the Workshop, eminent power electronics scholars from around the world will share their visions for the greener world and participate in the initial development of a power electronics technology roadmap for zero-carbon world by 2050.

We will keep our deliberations within the areas of expertise and scientific authority of the Workshop participants, i.e. in the areas of electrical engineering and specifically power electronics! Hence, it is reasonable to focus on replacing fossil fuels by 2050, because most estimates (e.g. figure below) show that ~3/4 of global sources of greenhouse gas emissions by humans come from the energy use.



Global greenhouse gas emissions by sector (2016)

Source: Climate Watch, the World Resources Institute (2020), <https://OurWorldinData.org/emissions-by-sector>

Within these boundaries, the Workshop deliberations will proceed along the following steps:

1. Estimate how much energy 10 billion humans living in a happier and more equitable world would consume in 2050.
2. Assuming that all the energy consumed in 2050 will come from “green sources,” estimate how much of it will be generated or consumed in the form of electricity, i.e. estimate the size of global electrical energy system infrastructure that humanity will need by 2050.
3. Devise several plausible architectures of the “2050 global electrical energy system infrastructure” considering:
  - a. Generation
  - b. Energy transportation and storage
  - c. Consumption

Plausibility should be based on physics, manufacturability at scale, and sustainable availability of raw materials and energy, and it should not be restricted by economic, policy, or social considerations, because we lack expertise and authority in the latter.

4. Down-select to a few representative “2050 global electrical energy system” architectures.
5. Use back-casting to project necessary electrical and power electronics technology advances for implementing the selected architectures.
6. Outline one or more roadmaps of technology advances and infrastructure construction over the next 25 years, which will plausibly lead to carbon-free World by 2050.
7. Estimate required resources, i.e. raw materials, energy, labor, and money (% of GDP) for the roadmap(s).
8. Prepare for dissemination of the initial results and involvement of a broader community.

After the Workshop opening, we will hear 17 positioning statements from the participants who volunteered to make them. These brief statements are expected to address points 1. through 5. above in as many slides, and not last more than 10 minutes. There will be only a couple of minutes for clarifying questions and answers after each presentation. The first day of the Workshop will end with plenary discussion of the positioning statements and 3 breakout sessions focusing on points (3) and (4) above.

In the second day (Sunday) morning, we will address points (5) and (6) above through both plenary and breakout sessions. The breakout groups will also take turns to visit the CPES Labs in the same building and engage in research dialogue with CPES@DC graduate students.

Because many of the aspects are very controversial and may need much deeper and longer studies, the intention of the Workshop is to bring forward the key issues and exchange the ideas. Therefore, we

- i. Will not try to develop consensual opinions;
- ii. Will try to keep a record of diverse ideas and disagreements;
- iii. May modify the above described deliberative process, as we go along;
- iv. May not get much beyond the step 5 above;
- v. Should explore if, who and how to proceed with further development of the power electronics technology roadmap for zero-carbon world by 2050.

#	Name		Institution	Country
1	Hirofumi	Akagi	Tokyo Institute of Technology	Japan
2	Kan	Akatsu	Yokohama National University	Japan
3	Tamara	Baksht	VisIC Technologies	Israel
4	Peter	Barbosa	Delta Electronics	Taiwan
5	Paul	Bauer	Delft University of Technology	Netherlands
6	Mohamed	Belkhayat	Newport News Shipbuilding	USA
7	Vlado	Blasko	Lockheed Martin Co.	USA
8	Dushan	Boroyevich	CPES - Virginia Tech	USA
9	Rolando	Burgos	CPES - Virginia Tech	USA
10	Stephanie	Butler	WattsButler LLC	USA
11	Kirk	Cameron	Virginia Tech	USA
12	Jimmy	Chiang	Acbel Polytech Inc.	Taiwan
13	José A.	Cobos	Universidad Politécnica de Madrid	Spain
14	Igor	Cvetkovic	Booz   Allen   Hamilton	USA
15	Rik	De Doncker	RWTH Aachen University (online)	Germany
16	Christina	DiMarino	CPES - Virginia Tech	USA
17	Deepak	Divan	Georgia Institute of Technology	USA
18	Dong	Dong	CPES - Virginia Tech	USA
19	Brian	Fan	CPES - Virginia Tech	USA
20	Tsuyoshi	Funaki	Osaka University (online)	Japan
21	Dennis	Grove	Center for Power Electronics Systems (CPES)	USA
22	Thomas	Harder	European Center for Power Electronics (ECPE)	Germany
23	Shiori	Idaka	Mitsubishi Electric	Japan
24	Sungmin	Kim	Hanyang University	Korea
25	Isik	Kizilyalli	Advanced Research Projects Agency - Energy	USA
26	Johann	Kolar	ETH Zurich	Switzerland

#	Name	Institution	Country	#
27	Fred	Lee	CPES - Virginia Tech	USA
28	Jinjun	Liu	Xi'an Jiaotong University	China
29	Leo	Lorenz	European Center for Power Electronics (ECPE)	Germany
30	Alan	Mantooth	University of Arkansas	USA
31	Paolo	Mattavelli	University of Padova	Italy
32	Jan	Michalik	University of West Bohemia - Plzeň	Czechia
33	Hiromichi	Ohashi	New-generation Power Electronics ... (NPERC-J)	Japan
34	Zdenek	Peroutka	University of West Bohemia - Plzeň	Czechia
35	Michael	Pesin	U.S. Department of Energy	USA
36	Jad	Rizk	Richtek USA	USA
37	Soenke	Rogalla	Fraunhofer Institute for Solar Energy Systems ISE	Germany
38	Jason	Rouse	Taiyo America	USA
39	Katsumi	Satoh	New-generation Power Electronics ... (NPERC-J)	Japan
40	Daniel	Sui	Virginia Tech	USA
41	Makoto	Takamiya	University of Tokyo	Japan
42	Keiji	Wada	Tokyo Metropolitan University	Japan
43	Rudy	Wang	Delta Electronics	USA
44	Ahmed	Yago	Crane Aerospace & Electronics	USA
45	Gary	Yao	Silergy Technology	USA
46	Richard	Zhang	CPES - Virginia Tech	USA
47	Yuhao	Zhang	CPES - Virginia Tech	USA



**Hirofumi Akagi** (Life Fellow, IEEE) received the Ph.D. degree in electrical engineering from the Tokyo Institute of Technology, Tokyo, Japan, in 1979. Since 2000, he has been a Professor, currently a Distinguished Professor, with the Tokyo Institute of Technology. Prior to it, he was with the Nagaoka University of Technology, Nagaoka, Japan, and Okayama University, Okayama, Japan.

He has authored and coauthored more than 140 IEEE Transactions/Journal papers. His research interests include power conversion systems and its applications. Akagi was the recipient of six IEEE Transactions Prize Paper Awards and 16 IEEE IAS Committee Prize Paper Awards. He was the recipient of the 2001 IEEE PELS William E. Newell Award, the 2004 IEEE IAS Outstanding Achievement Award, the 2008 IEEE Richard H. Kaufmann Award, the 2012 IEEE PES Nari Hingorani Custom Power Award, the 2018 IEEE Medal in Power Engineering, and the 2020 EPE Gaston Maggetto Medal. He served as the President of the IEEE Power Electronics Society from January 2007 to December 2008, and as the IEEE Division II Director from January 2015 to December 2016.



**Kan Akatsu** received B.S., M.S., and Ph.D. degrees in electrical engineering from Yokohama National University, Yokohama, Japan, in 1995, 1997, 2000 respectively. He joined Nissan Research Center, Yokosuka, Japan, in 2000, he contributed to the design and analysis of the new concept permanent magnet machines.

In 2003, he joined the department of Electrical and Electric Engineering at Tokyo University of Agriculture and Technology, Tokyo, Japan, as an assistant professor. From 2005 to 2007, he was a JSPS Postdoctoral Fellowship for Research Abroad, visiting professor in WEMPEC (Wisconsin Electric Machines and Power Electronics Consortium), University of Wisconsin-Madison. From 2009, he was an associate professor in Shibaura Institute of Technology, Tokyo, Japan. From 2015, he was a professor in Shibaura Institute of Technology, Tokyo, Japan. From 2019, he is a professor in Yokohama National University, Yokohama, Japan. His research interests are motor control, motor design and inverter control. Dr. Akatsu is a member of the IEEE PELS, IAS, IE and IEE of Japan.



**Tamara Baksht** is the Founder and CEO at VisIC Technologies. Her background education and work experience are from Tomsk State University in Russia with a Ph.D. in Electrical Engineering from Tel Aviv University and further work at Gal El (MMIC).

Tamara has 8 years of experience running multi-disciplinary GaN projects, defining work plans, budgeting, reporting, transferring products to production and providing customer support. Tamara received grants from the Chief Science Office, MAFAT, BIRD Foundation. The last major pre-VisIC achievement was the completion of Phase I of a multi-million USD, multi-year GaN program in August 2009, one year ahead of the initial schedule.





**Peter Barbosa** (Senior Member, IEEE) received the Ph.D. degree in electrical engineering from Virginia Polytechnic Institute and State University (Virginia Tech), Blacksburg, VA, USA, in 2002. From 2001 to 2003, he was the Technical Director with the Center for Power Electronics Systems, Virginia Tech. In 2003, he was with ABB Corporate Research, Baden, Switzerland, as a Scientist, and later as the Manager of the Power Electronics and System Applications Group.

At ABB, he developed innovative multilevel power converters for high-power applications by introducing novel hybrid multilevel power conversion concepts. Since 2008, he has been with Delta Electronics, first in Taiwan developing high-efficiency telecom power supplies and heading medium-voltage drive products, and recently the Director with Milan Jovanović Power Electronics Laboratory, Research Triangle Park, USA.



**Pavol Bauer** is currently a full Professor with the Department of Electrical Sustainable Energy of Delft University of Technology and head of DC Systems, Energy Conversion and Storage group. He received Masters in Electrical Engineering at the Technical University of Kosice ('85), Ph.D. from Delft University of Technology ('95) and title prof. from the president of Czech Republic at the Brno University of Technology (2008) and Delft University of Technology (2016). He is also honorary professor at Politechnica University Timisioara in Romania. From 2002 to 2003 he was working partially at KEMA (DNV GL, Arnhem) on different projects related to power electronics applications in power systems. He published over 110 journal and over 400 conference papers in his field (with H factor Google scholar 38, Web of Science 25), he is an author or co-author of 8 books, holds 5 international patents and organized several tutorials at the international conferences.

He has worked on many projects for industry concerning wind and wave energy, power electronic applications for power systems such as Smarttrafo; HVDC systems, projects for smart cities such as PV charging of electric vehicles, PV and storage integration, contactless charging; and he participated in several Leonardo da Vinci, H2020 and Electric Mobility Europe EU projects as project partner (ELINA, INETELE, E-Pragmatic, Micact, Trolley 2.0, OSCD) and coordinator (PEMCWebLab.com-Edipe, SustEner, Eranet DCMICRO).

He is a Senior Member of the IEEE ('97), former chairman of Benelux IEEE Joint Industry Applications Society, Power Electronics and Power Engineering Society chapter, chairman of the Power Electronics and Motion Control (PEMC) council, member of the Executive Committee of European Power Electronics Association (EPE) and also member of international steering committee at numerous conferences.



**Mohamed Belkhat** received the Ph.D. degree in energy systems from the Department of Electrical Engineering (EE), Purdue University, West Lafayette, IN, USA, in 1997. He is currently a Senior Research Engineer with Huntington Ingalls Industries Newport News Shipbuilding, Newport News, VA, USA, serving as a power and energy subject matter expert. He has been working in the field for more than 30 years. He has published numerous articles on the stability of integrated dc and ac power systems. He also holds several patents in the field.

His research spans a wide range of energy sources, including nuclear, hydrocarbon, wind, solar, and sea waves. He also researched various conversion processes, including thermo-photovoltaics, high-voltage power electronics, and rotating machinery. He taught for more than ten years, energy conversion, controls, and modeling and simulation at the Naval Post Graduate School in Monterey, CA, at Qatar University, Doha, Qatar, and at George Washington University, Washington, DC, USA, where he is currently an Adjunct Professor. He works in the Washington.



**Vladimir Blasko** (Member of US National Academy of Engineering, IEEE fellow) Dr. Blasko's primary research interests include power electronics, modern AC drives, distributed energy systems, intelligent power management and applied modern control theory and technology. At the beginning of his career he worked for the Research Institute of the Koncar Company, in Zagreb, Croatia, before joining Rockwell Automation-The Allen Bradley Company in Milwaukee, Wisconsin.

At the Otis Elevator Company, he initiated and led the development of a new generation of high-performance regenerative drives. He then became a senior fellow at the United Technologies Research Center, setting the research direction, strategies and roadmaps for the center as well as setting up research collaborations with universities and other organizations. Currently, he is a senior manager for the Sikorsky Aircraft Corporation, a Lockheed Martin Company, based in Stratford, Connecticut. Dr. Blasko is a member of the U.S. National Academy of Engineering for his contributions to the theory and practice of regenerative electrical drives and grid-tied converters.



**Dushan Boroyevich** received the Dipl. Ing. degree from the University of Belgrade, Yugoslavia, in 1976, the M.S. degree from the University of Novi Sad, Yugoslavia, in 1982, and the Ph.D. degree from Virginia Polytechnic Institute and State University (Virginia Tech), Blacksburg, VA, USA, in 1986. From 1986 to 1990, he was an Assistant Professor and the Director of the Power and Industrial Electronics Research Program, Institute for Power and Electronic Engineering, University of Novi Sad. Then, he was an Associate Professor with the Bradley Department of Electrical and Computer Engineering, Virginia Tech, where he is currently the University Distinguished Professor with the Department and the Deputy Director of the Center for Power Electronics Systems.

His research interests include electronic power distribution systems, multiphase power conversion, power electronics systems modeling and control, and integrated design of power converters. He was the President of the IEEE Power Electronics Society for 2011-2012. He is a Member of the U.S. National Academy of Engineering. He was the recipient of four honorary professorships and numerous other awards, including the IEEE William E. Newell Power Electronics Technical Field Award and European Power Electronics Association (EPE) Outstanding Achievement Award.



**Rolando Burgos** received the B.S. degree in electronics engineering, the Electronics Engineering Professional degree, and the M.S. and Ph.D. degrees in electrical engineering from the University of Concepción, Chile, in 1995, 1997, 1999, and 2002, respectively. In 2002, he joined the Center for Power Electronics Systems (CPES), Virginia Tech, Blacksburg, VA, USA, as a Post-Doctoral Fellow, becoming a Research Scientist in 2003, and a Research Assistant Professor in 2005.

In 2009, he joined ABB Corporate Research, Raleigh, NC, USA, where he was a Scientist from 2009 to 2010, and a Principal Scientist from 2010 to 2012. In 2010, he was appointed an Adjunct Associate Professor with the Electrical and Computer Engineering Department, Future Renewable Electric Energy Delivery and Management (FREEDM) Systems Center, North Carolina State University, Raleigh, NC.

In 2012, he returned to Virginia Tech, as an Associate Professor with The Bradley Department of Electrical and Computer Engineering, where he earned his tenure in 2017, was promoted to a Professor in 2019. Since

2021, he has been the Director of CPES. His research interests include high-power density wide bandgap semiconductor-based power conversion—low-voltage and medium-voltage applications, packaging and integration, electromagnetic interference (EMI) and electromagnetic compatibility (EMC), multiphase multilevel power converters, modeling and control, grid power electronics systems, and the stability of ac and dc power systems.

Dr. Burgos is a member of the IEEE Power Electronics Society where he currently serves as an Associate Editor for the IEEE Transactions on Power Electronics and the IEEE Journal of Emerging and Selected Topics in Power Electronics. He is also a member of the IEEE Industry Applications Society, the IEEE Industrial Electronics Society, and the IEEE Power and Energy Society. He is the past Chair of the Technical Committee on Power and Control Core Technologies.



**Stephanie Watts Butler**, Ph.D., P.E., is the President of WattsButler LLC, an innovation services company focused on the power semiconductor industry. During her previous career at Texas Instruments, she produced innovations in the areas of power and CMOS process and package technology, processing equipment, materials, reliability, research and development management, manufacturing science, control, fault detection, metrology, and new product development generating 17 U.S. patents.

She is the Co- Founder and the Past-Chair of JEDEC's JC-70 Wide Bandgap Standards Committee, the Co-Convenor of IEC's TC47/ WG8. She is the Industry Deputy Editor-in-Chief of IEEE Power Electronics Magazine, a PELS Member-at-Large (ADCOM), the Chair of the PELS Industry Committee, and a WIE Committee Member. She also serves on the APEC Planning Committee and the PSMA Semiconductor Committee.



**Kirk W. Cameron**, Ph.D. is a Professor of Computer Science at Virginia Tech and an IEEE Fellow. As of August 2021, he is the inaugural faculty lead (i.e., department head) at Virginia Tech's Innovation Campus. From 2012-2022, he was Director of the stack@cs Center for Computer Systems (recently ranked #26 by US News). He is a Distinguished Member of the ACM; and an associate editor for the Journal of Parallel and Distributed Computing and for IEEE Transactions on Parallel and Distributed Computing. From 2018-2022 he was Associate Department Head for Research and Engagement.

He was Associate Department Head and Graduate Program Director from 2014-2017. From 2017-2018, Prof. Cameron held a Distinguished Visiting Fellowship at Queen's University Belfast from the U.K. Royal Academy of Engineering.

The central theme of his research is to improve power and performance efficiency in high performance computing (HPC) systems and applications. Accolades for his work include NSF and DOE Career Awards, IBM and AMD Faculty Awards, and being named Innovator of the Week by Bloomberg Businessweek Magazine. He pioneered Green Computing (Green500, SPECpower, PowerPack, grano.la) and his power measurement and management software has been downloaded by more than 500,000 people in 160+ countries. He is a recipient of the HPDC 2017 Best Paper Award and his educational SeeMore kinetic cluster was named the second best RaspberryPi project of all time by MagPi Magazine. His work consistently appears in The New York Times, The Guardian, Time, Newsweek, etc. His educational LACE kinetic sculpture (pictured above) recently appeared at the Smithsonian National Museum of American History in Washington, D.C.



**Jimmy Chiang** is a Vice President at AcBel Polytech, which is a Computer Equipment & Peripherals company with an estimated 8,342 employees; and founded in 1981. The Company's products include personal computer (PC) power supplies, web server power supplies, telecom power supplies, low voltage switching regulators, and direct current (DC)/DC converters.



**José Antonio Cobos** received his Electrical Engineering and Doctoral degrees from UPM, in 1989 and 1994, respectively. He is a Full Professor at the Technical University of Madrid (UPM), Madrid, Spain since 2001. His contributions are focused in the field of power supply systems for telecom, aerospace, industrial, automotive and medical applications. His research interests include energy efficiency in digital circuits and RF amplifiers, magnetic components, piezoelectric transformers, transcutaneous energy transfer, and dynamic power management. He published more than 300 technical papers (h-index 38), and holds nine patents. He advised 13 Doctoral dissertations and more than 40 Master Thesis.

He was the Director of the “Centro de Electrónica Industrial, CEI-UPM” (2006–2007 and 2011–2015), a university research center, leading a strong industrial program in power electronics, with technology transfer through direct R&D contracts with more than 30 different companies in Europe, U.S., Australia, and China. At ETSII-UPM, he was the Vice-Dean for Academic Affairs, the Vice-Dean for Research & Doctorate, and the President of the Alumni Association. Dr. Cobos received some awards which include Semikron Innovation Award for the teamwork on “RF Power Amplifier with Increased Efficiency and Bandwidth,” the Google “Little Box Challenge” Award to develop the smallest possible inverter for PV panels and high density batteries, and in 2000, the “Richard Bass Outstanding Young Power Electronics Award of the IEEE.”

He has been cooperating with the IEEE and other professional associations (Technical Committee Chair, Associate Editor, and Adcom member). He is a Member of the Steering committee of IEEE-APEC (Expo Chair) and the General Chair for the PwrSoC 2016.



**Igor Cvetkovic** (Member, IEEE) received the Dipl. Ing. degree from the University of Belgrade, Belgrade, Serbia, in 2004, and the M.S. and Ph.D. degrees from Virginia Polytechnic Institute and State University (Virginia Tech), Blacksburg, VA, USA, in 2010 and 2017, respectively. From 2004 to 2007, he was an Engineer with the Electric Power Industry of Serbia, Belgrade, Serbia.

From 2010 to 2022, he progressed from Research Engineer to Research Scientist and then became a Technical Director with the Center of Power Electronics Systems, Virginia Tech. He has since joined Booz Allen Hamilton as a lead engineer serving as Science and Engineering Technical Advisor to ARPA-E.

His research interests include AC- and DC-electronic power distribution systems design, modeling, and control, system-level dynamic interactions, on-line stability monitoring, black-box low-frequency terminal behavioral modeling of converters and systems, and power electronics converters electro-thermo-mechanical design and integration. He became a Member of the Medium-Voltage DC Distribution Systems Working Group, CIGRE.





**Rik W. De Doncker** received the Ph.D. degree in electrical engineering from the Katholieke Universiteit Leuven, Leuven, Belgium, in 1986. In 1987, he was appointed as a Visiting Associate Professor with the University of Wisconsin, Madison, WI, USA. After a short stay as an Adjunct Researcher with Interuniversity Microelectronics Centre, Leuven, he joined, in 1989, the Corporate Research and Development Center, General Electric Company, Schenectady, NY, USA. In 1994, he joined Silicon Power Corporation, a former division of General Electric Inc., as the Vice President of Technology. In 1996, he became a Professor with RWTH Aachen University, Aachen, Germany, where he Electronics and Electrical Drives. Since 2006, he has been the Director of the E.ON Energy Research Center, RWTH Aachen University. Dr. DeDoncker was the President of the IEEE Power Electronics Society (PELS) in 2005 and 2006. He was the Founding Chairman of the German IEEE Industry Applications Society PELS Joint Chapter. He was the recipient of the IEEE IAS Outstanding Achievement Award in 2002, IEEE PES Nari Hingorani Custom Power Award in 2008, IEEE William E. Newell Power Electronics Award in 2013, and honorary doctoral degree of TU Riga, Latvia, in 2010. In 2009, he led a VDE/ETG Task Force on Electric Vehicles.



**Christina DiMarino** is an assistant professor in the Electrical and Computer Engineering Department at Virginia Tech and faculty in the Center for Power Electronics Systems (CPES). She received her M.S. and Ph.D. degrees in electrical engineering from Virginia Tech in 2014 and 2018, respectively.

Her research interests include power electronics packaging and high-density integration of wide-bandgap power semiconductors. She has received five best paper and presentation awards at international conferences and was awarded the Outstanding New Assistant Professor Award at Virginia Tech in 2022.

She is a Member-at-Large for the IEEE Power Electronics Society (PELS), Chair for the PELS Technical Committee 2 on Power Components, Integration, and Power ICs, an Associate Editor for the IEEE Transactions on Power Electronics, and is a member of the PELS Women in Engineering (WIE) Committee. She has also served on the technical committees for several IEEE conferences.



**Deepak Divan** is Professor, John E Pippin Chair, GRA Eminent Scholar, and Director of the Center for Distributed Energy at the Georgia Institute of Technology in Atlanta, GA. His field of research is in the areas of power electronics, power systems, smart grids, and distributed control of power systems. He works closely with utilities, industry and is actively involved in research, teaching, entrepreneurship and starting new ventures.

Dr. Divan also serves as Founder and Chief Scientist at Varentec, in Santa Clara, CA, and was President and CTO from 2011-14, leading the company as it developed its suite of innovative distributed real-time grid control technologies. Varentec is funded by leading green-tech Venture Capital firm Khosla Ventures and renowned investor Bill Gates.

Dr. Divan is an elected Member of the US National Academy of Engineering, member of the National Academies Board on Energy and Environmental Systems, a Fellow of the IEEE, past President of the IEEE Power Electronics Society, and is a recipient of the IEEE William E Newell Field Medal. He has 40 years of academic and industrial experience, 65 issued and pending patents, and over 400 refereed publications. He has founded or seeded several new ventures including Soft Switching Technologies, Innovolt, Varentec and Smart Wires, which together have raised >\$160M in venture funding. He received his B. Tech from IIT Kanpur, and his M.S. and Ph.D. degrees from the University of Calgary, Canada.





**Dong Dong** received the B.S. degree from Tsinghua University, Beijing, China, in 2007, and the M.S. and Ph.D. degrees in electrical engineering from Virginia Tech, Blacksburg, VA, USA, in 2009 and 2012, respectively. From 2012 to 2018, he was an Electrical Engineer with GE Global Research Center, Niskayuna, NY, USA. At GE, he participated in and led multiple technology programs, including MV/HVDC power distribution and power delivery, SiC high-frequency high-power conversion systems, solid-state transformers, and energy storage system.

Since 2018, he has been with the Bradley Department of Electrical and Computer Engineering, Virginia Tech. He has authored or coauthored more than 30 referred journal publications and more than 80 IEEE conference publications. He currently holds 30 granted U.S. patents. His research interests include wide-band-gap power semiconductor-based high frequency power conversion, soft-switching and resonant converters, high-frequency transformers, and MV and HV power conversion system for grid, renewable, and transportation applications. He is currently an Associate Editor for the IEEE Transactions on Power Electronics.

He was the recipient of the GE gold Medallion Patent Award and GE technology transition awards. He was also the recipient of the two Prize Paper Awards from the IEEE Transactions on Power Electronics and IEEE Transactions on Industry Applications, William Portnoy Prize Paper Award from IEEE IAS, and NSF CAREER Award. He was the Vice Chair of IEEE Industry Application Society Schenectady Region Chapter in 2017 and General Chair of IEEE International Conference on DC Microgrids in 2021.



**Boran Fan** received the B.S. and Ph.D. degrees in electrical engineering from Tsinghua University, Beijing, China, in 2013 and 2018, respectively. In 2018, he joined the Center for Power Electronics Systems, Virginia Tech, Blacksburg, VA, USA, as a Postdoctoral Fellow and became a Research Scientist in 2021. His research interests include topology and control of multilevel power converters, renewable energy generation, wide-bandgap semiconductor applications, electromagnetic interference, and electromagnetic compatibility.



**Tsuyoshi Funaki**, Professor at Osaka University, Graduate school of Engineering, Division of Electrical, Electronic and Infocommunications Engineering.

He is a principle investigator (PI) of Power System Laboratory in Division of Electrical, Electronic and Information Engineering, Graduate School of Engineering in Osaka University. He is currently working on the research and development of renewable energy system and smart grid technology based on power electronics using incoming wide band gap semiconductor power devices; e.g. SiC, GaN, and also working on reliability assessment of power supply facilities.

He received the B.E. and M.E. degrees in electrical engineering and the Ph.D. degree all from Osaka University, Osaka, Japan. He was on the staff of Research Associate with Osaka University in 1994, and promoted to Associate Professor in 2001. In 2002, he was an Associate Professor with Kyoto University. Now, he has been a full Professor with Osaka University since 2008.



**Dennis Grove** has more than 25 years of experience of program, financial, research, and administrative management at leading academic and research organizations including US Department of Energy's Ames National Laboratory, Yale University's School of Medicine and School of Forestry and Environmental Sciences, and Virginia Tech.

He currently serves as the Industry Program Director for CPES. Dennis earned an MS in Organic Chemistry and an MBA from Iowa State University.



**Thomas Harder** received the diploma degree in physics from the University of Kiel, Kiel, Germany. He has more than 15 years of experience in packaging and interconnection technologies for microsystems and multichip modules.

He was a Researcher in the Fraunhofer Institute for Silicon Technology (ISIT), Itzehoe, Germany. Since 2003, he has been the General Manager of European Center for Power Electronics, an industry-driven research network, Nuremberg, Germany.



**Shiori Idaka** joined Mitsubishi Electric's Advanced Technology R&D Centre in 2002. There, she was involved in the development of various semiconductor packages, including LSIs, MEMS sensors, high-frequency and optical devices, power devices.

In December 2016, she moved to the German branch of Mitsubishi Electric Europe B.V. and launched the European Research Cooperation Centre in 2017, where she is responsible for the coordinating of research and development projects on power electronics. She is also a member of the Department of Electrical Engineering at Nagoya University since 2014.



**Sungmin Kim** received the B.S., M.S., and Ph.D. degrees in electrical engineering from Seoul National University, Korea, in 2003, 2009, and 2014 respectively. From 2012 to 2013, he was a Visiting Scholar with the FREEDM Systems Center, North Carolina State University, USA. From 2014 to 2015, he was a Senior Engineer at the Samsung Electronics Company, Korea.

Since 2015, he has been with Hanyang University ERICA Campus, where he is presently working as Associate Professor in the School of Electrical Engineering. His current research interests include power converter circuits design and control, high performance machine drive system, and medium/high voltage DC Grid.



**Isik C. Kizilyalli** currently serves as the Associate Director for Technology at the Advanced Research Projects Agency – Energy (ARPA-E). In this role, Dr. Kizilyalli supports the Deputy Director for Technology in oversight of all technology issues relating to ARPA-E’s programs as well as assisting with program development, Program Director and Fellow recruitment, and coordinating project management across the Agency.

Kizilyalli’s focus at ARPA-E includes power electronics, wide bandgap semiconductors, electronic systems for hostile environments, electrification of transport (aviation, ships, automotive), subsurface instrumentation, novel drilling concepts, medium voltage DC distribution grids, and grid resiliency against EMP and space weather threats. Prior to joining ARPA-E, Kizilyalli served as founder, Chief Executive Officer, and Chief Technical Officer of Avogy Inc., a venture backed start-up focused on bulk GaN based vertical power semiconductor technologies and power electronics. Previously, he was with Bell Laboratories, followed by Nitronex Corporation, and solar PV startup Alta Devices where his team holds the world record for single junction solar cell conversion efficiency.

Kizilyalli was elected a Fellow of the Institute of Electrical and Electronics Engineers (IEEE) in 2007 for his contributions to Integrated Circuit Technology. He also received the Bell Laboratories’ Distinguished Member of Technical Staff award and the Best Paper Award at the International Symposium on Power Semiconductors and Integrated Circuits in 2013. Kizilyalli holds his B.S. in Electrical Engineering, M.S. in Metallurgy, and Ph.D. in Electrical Engineering from the University of Illinois Urbana-Champaign. He has published more than 100 papers and holds 120 issued U.S. patents.



**Johann W. Kolar** (Fellow, IEEE) is an International Member of the U.S. National Academy of Engineering and a Full Professor and the Head of the Power Electronic Systems Laboratory at the Swiss Federal Institute of Technology (ETH) Zurich.

The focus of his current research is on ultra-compact/efficient WBG PFC rectifier and inverter systems, ultra-high bandwidth switch-mode power amplifiers, multi-port converters, solid-state transformers, multi-functional actuators, ultra-high speed/motor-integrated drives, bearingless motors, ANN-based multi-objective design optimization, and life cycle analysis of power electronics converter systems.



**Fred C. Lee** (Life Fellow, IEEE) received the B.S. degree from National Cheng Kung University, Tainan City, Taiwan, in 1968, and the M.S. and Ph.D. degrees from Duke University, Durham, NC, USA, in 1972 and 1974, respectively, all in electrical engineering. He is a University Distinguished Professor Emeritus with Virginia Polytechnic Institute and State University (Virginia Tech), Blacksburg, VA, USA, and the Founder and Director Emeritus of the Center for Power Electronics Systems, an engineering research center consisting of 80 corporations. The mission of the center is “to provide leadership through global collaboration to create electric power processing systems of the highest value to society.” His research interests

include high-frequency power conversion, magnetics and EMI, distributed power systems, renewable energy, power quality, high-density electronics packaging and integration, and modeling and control. He holds 105 U.S. patents, and has authored or coauthored more than 335 journal articles and more than 780 refereed technical papers. During his tenure with Virginia Tech, he has supervised to completion 88 Ph.D. and 93 master's students.

Dr. Lee was the President of the IEEE Power Electronics Society (1992–1994) and is a recipient of the William E. Newell Power Electronics Award in 1989; PCIM Award for Leadership in Power Electronics Education presented at HFPC in 1990; the Arthur E. Fury Award for Leadership and Innovation in 1998; the Honorary Sun Yuen Chuan Chair Professor of National Tsing Hua University in Taiwan in 2001; the Ernst-Blickle Award sponsored by SEW-EURODRIVE Foundation in 2005; the Distinguished Alumni Award from National Cheng Kung University in 2006; the Honorary Li Kwoh-Ting Chair Professor of National Cheng Kung University in 2011; Inaugural Member of the Virginia Tech Entrepreneur Hall of Fame in 2012; Honorary Chair Professor of National Chiao Tung University in Taiwan in 2014; Honorary Chair Professor of Tsinghua University in China in 2017; and Honorary Professor of Huazhong University of Science and Technology in China in 2018.

He is a member of the U.S. National Academy of Engineering, an Academician of the Academia Sinica in Taiwan, and a Foreign Member of the Chinese Academy of Engineering in the People's Republic of China. He is also a recipient of the IEEE Medal in Power Engineering in 2015 “for contributions to power electronics, especially high-frequency power conversion,” and the Power Supply Technology Outstanding Achievement Award from China Power Supply Society (CPSS) in 2017. He was elected as National Academy of Inventors (NAI) Fellow in 2018, and endorsed in 2019 as a Leader in engineering and education with the Albert Nelson Marquis Lifetime Achievement Award.



**Jinjun Liu** (Fellow, IEEE) received the B.S. and Ph.D. degrees in electrical engineering from Xi'an Jiaotong University (XJTU), Xi'an, China, in 1992 and 1997, respectively. He was a faculty with the School of Electrical Engineering, XJTU. From late 1999 to early 2002, he was with the Center for Power Electronics Systems, Virginia Polytechnic Institute and State University, Blacksburg, VA, USA, as a Visiting Scholar. In late 2002, he was a Full Professor and then the Head of the Power Electronics and Renewable Energy Center, XJTU, which now comprises more than 20 faculty members and more than 200 graduate students and carries one of the leading power electronics programs in China. From 2005 to early 2010, he was an Associate Dean with the School of Electrical Engineering, XJTU, and from 2009 to early 2015, the Dean for Undergraduate Education of XJTU. He is currently a XJTU Distinguished Professor of Power Electronics. He coauthored 3 books (including one textbook), authored and coauthored more than 500 technical papers in peer-reviewed journals and conference proceedings, holds more than 70 invention patents (China/US/Europe), and delivered for many times plenary keynote speeches and tutorials at IEEE conferences or China national conferences in power electronics area.

His research interests include modeling, control, and design methods for power converters and electrified power systems, power quality control and utility applications of power electronics, and microgrids for sustainable energy and distributed generation. Dr. Liu was the recipient of many times governmental awards at national level or provincial/ministerial level for scientific research/teaching achievements. He was also the recipient of the 2006 Delta Scholar Award, the 2014 Chang Jiang Scholar Award, the 2014 Outstanding Sci-Tech Worker of the Nation Award, the 2016 State Council Special Subsidy Award, IEEE Transactions on Power Electronics 2016 and 2021 Prize Paper Awards, the Nomination Award for the Grand Prize of 2020 Bao Steel Outstanding Teacher Award, and the 2022 Fok Ying Tung Education and Teaching Award. He was the IEEE Power Electronics Society Region 10 Liaison and then China Liaison for ten years. Since 2006, he has been an Associate Editor for the IEEE Transactions on Power Electronics, 2015–2019 Executive Vice President and 2020–2021 Vice President of IEEE Power Electronics Society.

He was on the Board of China Electrotechnical Society 2012–2020 and was elected the Vice President in 2013 and the Secretary General in 2018 of the CES Power Electronics Society. He was the Vice President for International Affairs, China Power Supply Society from 2013 to 2021, and since 2016, the inaugural Editor-in-Chief of CPSS Transactions on Power Electronics and Applications. He was elected the President of CPSS in November 2021. Since 2013, he has been the Vice Chair of the Chinese National Steering Committee for College Electric Power Engineering Programs.





**Leo Lorenz** was born in Haibach, Germany, in 1946. He received the Dipl.-Ing. degree from the Technical University of Berlin, Berlin, Germany, in 1976 and the Dr.-Ing. degree from the University of Federal Defence, Munich, Germany, in 1984. From 1976 to 1980, he was with AEG, R&D–Center for Power Electronics, Berlin.

In 1984, he joined Siemens Semiconductor Division which became Infineon Technologies AG, Munich, Germany, in 1999. Since then he has worked on power semiconductor and power ICs in different functions and responsibilities.

He has published over 200 technical papers in these fields. In 2001, he became a Professor for system integration at the University of Ilmenau, Ilmenau, Germany. Dr. Lorenz is President of the ECPE (European Center of Power Electronics).



**H. Alan Mantooth** (Fellow, IEEE) received the B.S. and M.S. degrees in electrical engineering from the University of Arkansas, Fayetteville, AR, USA, in 1985 and 1986, respectively, and the Ph.D. degree from Georgia Tech, Atlanta, GA, USA, in 1990. He then joined Analog, a startup company in Oregon. In 1998, he joined the Faculty of the Department of Electrical Engineering, University of Arkansas, where he is currently holding the rank of Distinguished Professor. His research interests include analog and mixed-signal IC design and CAD, semiconductor device modeling, power electronics, power electronic packaging, and cybersecurity.

He established the National Center for Reliable Electric Power Transmission (NCREPT) and is currently the Executive Director. He is the Founding Director of the NSF Industry/University Cooperative Research Center on GGrid-connected Advanced Power Electronic Systems (GRAPES) and the Deputy Director of the POETS NSF Engineering Research Center. He holds the 21st Century Research Leadership Chair of engineering. He is a Past-President of the IEEE Power Electronics Society and the Editor-in-Chief of the IEEE Open Journal of Power Electronics. He is a member of Tau Beta Pi, Sigma Xi, and Eta Kappa Nu, and registered professional engineer in Arkansas.



**Paolo Mattavelli** (Fellow, IEEE) received the M.S. (Hons.) and Ph.D. degrees in electrical engineering from the University of Padova, Padova, Italy, in 1992 and 1995, respectively. He is currently a Full Professor with the University of Padova. His current Google scholar H-index is 80. His major research interests include analysis, modeling, and analog and digital control of power converters, grid-connected converters for renewable energy systems and microgrids, and high-temperature and high-power-density power electronics.

Dr. Mattavelli was an Associate Editor for the IEEE Transactions on Power Electronics from 2003 to 2012. He is a Co-Editor-in-Chief for the IEEE Transactions on Power Electronics. From 2005 to 2010, he was the Industrial Power Converter Committee Technical Review Chair for the IEEE Transactions on Industry Applications. For terms 2003–2006, 2006–2009, and 2013–2015, he was a member-at-large of the IEEE Power Electronics Society's Administrative Committee.

He was a recipient of the Prize Paper Award in the IEEE Transactions on Power Electronics in 2005, 2006, 2011, and 2012, and the 2nd Prize Paper Award at the IEEE Industry Applications Society Annual Meeting in 2007.





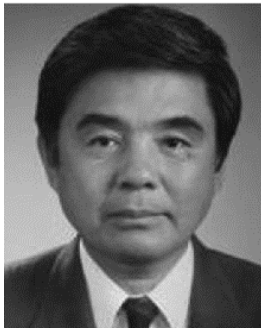
**Jan Michalik** | Vice-dean for International Relations and Communication Faculty of Electrical Engineering

Research activities of Dr. Michalik concern power electronics converters control, mainly current-source based, control algorithms development and microprocessor based control systems. In recent time, Dr. Michalik focused his research mainly on predictive control theory applied to current-source converters. In selection, in 2007, he was an invited lecturer at the University of Vigo, Spain, where he made lectures introducing Control structures of single phase current-source rectifiers.

In 2015, he was one of the senior engineers responsible for strategic transfer of technology in the field of light traction drive design to the industrial partner in China. In 2016, he was the invited speaker at ECPE workshop: Model Predictive Control in Power Electronics - Expectations and Applications.

He has received the best paper award in EDPE 2007, and the Dean of the Faculty of Electrical Engineering award in 2007. He has also been chair of sessions at EPE-PEMC 2010, IECON2015 and IECON2016, where he also obtained Best session presentation award. Dr. Michalik serves as a reviewer at several international conferences and in distinguished journals such as the IEEE Transactions on Power Electronics and also as a reviewer of national and international doctoral and Ph.D. thesis.

Dr. Michalik published 2 papers in international journals with impact factor (both of them were invited) and more than 50 papers in other national and international journals and conferences. Public scientific resources (WoS, IEEEExplore, scholar.google.com) recognize more than 220 citations to his papers and h-index 8 (Google scholar).



**Hiromichi Ohashi** received the B.S. degree from Hosei University, Tokyo, Japan, in 1964, the M.S. degree from Sophia University, Tokyo, Japan, in 1969, both in electronics, respectively, and the Ph.D. degree in electronics from Tohoku University, Sendai, Japan, in 1990. From 1969 to 2002, he joined the Corporate Research and Development Center, Toshiba Corporation. From 2003 to 2005, he was a Professor of Tokyo Institute of Technology. Since 2003, he has been an Invited Senior Research Scientist in the National Institute of Advanced Industrial Science and Technology, Tsukuba, Japan.

He has more than 100 patents and more than 100 journal and international conference publications. His current interests include advanced power devices, related materials and power electronics system integration, and network. Dr. Ohashi is a Fellow member of the IEE Japan and a Life Member of the IEEE. He was the General Chairman of the International Symposium on Power Semiconductor Devices'95. He is a recipient of the Medal with Purple Ribbon from the Japan Government for his contribution to the development of high power light triggered thyristors for power transmission network of Japan.



**Zdeněk Peroutka** received the master's and Ph.D. degrees in electrical engineering from the University of West Bohemia (UWB), Pilsen, Czech Republic, in 2000 and 2004, respectively. He is a Full Professor of Power Electronics and Drives and the Dean of the Faculty of Electrical Engineering, UWB. From October 2010 to June 2016, he was a Scientific Director and Principal Investigator with the R&D Center RICE, UWB. Since July 2016, he has been a CEO and Principal Investigator with the R&D Center RICE.

He has authored or coauthored more than 200 papers in international journals and conference proceedings. He is the Inventor of three international patents and three utility models. His main research interests include power electronics and drives for modern transport systems and power engineering.



**Michael Pesin** is acting Deputy Assistant Secretary for the Grid Controls and Communications Division in DOE's Office of Electricity. His division is responsible for the development and management of projects for next-generation electricity delivery technologies and supporting activities to accelerate their introduction to the marketplace.

Mr. Pesin has over 35 years of experience in the electric utility industry directing development and execution of advanced technology programs. Mr. Pesin is a licensed professional engineer and spent most of his career leading technology organizations at electric utility companies where he led technology strategy development, managed research and development programs, and directed strategic programs and demonstration projects in generation, transmission, distribution, system protection, advanced metering infrastructure, communication networks and cybersecurity, energy storage, microgrids, electric vehicles, transactive energy, and other advanced technologies.

Prior to joining DOE, Mr. Pesin was also the founder and president of a consulting company working with electric utilities, technology companies, and investors. He served as a board member at a number of technology organizations, is actively involved with many electric power industry groups, and is a frequent speaker at industry events.



**Jad Rizk**, Vice President – Enterprise Power / US Design Center at Richtek.

Jad Rizk received his Ph.D. degree from the University of Michigan, Ann Arbor, in 2003, where his research focused on MEMS circuits and antennas for W-band applications. In 2003, he joined Intel Corporation, Hillsboro, OR, where he worked on wireless circuits development and device characterization on 90 nm CMOS technology.

He was then involved in high-speed IO and LCPLL development on multiple process technologies from 65 nm to 32 nm. He is currently managing the Wireless Circuit Technology Group at Intel focusing on 22 nm and 14 nm CMOS nodes.



**Soenke Rogalla** received the Diplom-Ingenieur degree in electrical engineering and information technology from the Karlsruhe Institute of Technology (KIT), Karlsruhe, Germany, in 2006, and the Ph.D. degree in electrical engineering from the University of Braunschweig—Institute of Technology, Germany, in 2020. Since 2006, he has been with the Fraunhofer Institute for Solar Energy Systems, Freiburg, Germany.

He was responsible for different research groups in the fields of PV inverter development, high power electronics, inverter testing, PV system concepts, grid interaction of converters, and grid-forming converters. Since 2022, he has been the Co-Head of the Department Power Electronics and Grid Integration.



**Jason Rouse** is a Strategic Growth & Ventures Manager at Taiyo America (Taiyo Holdings of Japan) where he oversees venture capital investments, new business partnerships, and Tier-1/OEM interactions.

Prior to joining Taiyo, he worked at leading global materials companies including Corning, Sekisui Chemical, Wacker Chemie, and Sun Chemical/DIC. In these roles, he leads the global development and commercialization of innovative technologies for the electronics and cleantech industries.

Jason serves on the ECTC Advanced Manufacturing Technology and IMAPS Device Packaging Conference committees, and helps organize multiple PSMA events. He holds an MBA from Fordham University, a PhD from Lehigh University, and a BA from Alfred University.



**Katsumi Satoh** joined Mitsubishi electric corp. in 1984. He previously worked on development of high power semiconductors such as a high voltage thyristor, a light triggered thyristor, GTO and GCT for high power transmission systems in Mitsubishi Electric Corporation.

His current research interests include power device chips technology and packaging technology for power modules. He received Doctor of Engineering degree from Kyusyu University, Japan in 2000. He received First Prize Paper Award from IEEE in 2001.



**Daniel “Dan” Sui**, an internationally renowned geographer/GIScientist with research interests focusing on GIS-based spatial analysis and modeling for urban, environmental, and public health applications, was appointed Virginia Tech’s vice president for research and innovation in the fall of 2020.

An established researcher and invited public speaker, Sui has published more than 230 scholarly publications covering various interdisciplinary topics and delivered approximately 70 keynote speeches, endowed, or invited guest lectures over the past five years.

Leading the Office of Research and Innovation, Sui reports to Executive Vice President and Provost Cyril Clarke. He is also a member of the president’s cabinet and council. Also, as chief research and innovation officer, Sui is responsible for supporting and growing Virginia Tech’s research portfolio and chairs the board of Virginia Tech Intellectual Properties.



**Makoto Takamiya** (S'98-M'00-SM'14) received the B.S., M.S., and Ph.D. degrees in electronic engineering from the University of Tokyo, Japan, in 1995, 1997, and 2000, respectively. In 2000, he joined NEC Corporation, Japan, where he was engaged in the circuit design of high-speed digital LSI's. He joined University of Tokyo, Japan in 2005, where he is now a Professor of Institute of Industrial Science. From 2013 to 2014, he stayed at University of California, Berkeley as a visiting scholar.

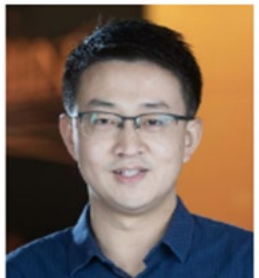
His research interests include the digital gate driver and sensor ICs for power electronics and the integrated power management circuits for automotive and industrial applications. He is a member of the technical program committee of IEEE Symposium on VLSI Circuits and IEEE Asian Solid-State Circuits Conference. He formerly served on the technical program committees of IEEE International Solid-State Circuits Conference (ISSCC) from 2015 to 2020 and IEEE Custom Integrated Circuits Conference from 2006 to 2011.

He was a Far East Regional Chair in ISSCC 2020. He was a Distinguished Lecturer of IEEE Solid-State Circuits Society from 2019 to 2020. He received 2009 and 2010 IEEE Paul Rappaport Awards and the best paper award in 2013 IEEE Wireless Power Transfer Conference.



**Keiji Wada** (Senior Member, IEEE) received the Ph.D. degree in electrical engineering from Okayama University, Okayama, Japan, in 2000. From 2000 to 2006, he was an Assistant Professor with Tokyo Metropolitan University and the Tokyo Institute of Technology.

He became an Associate Professor in 2006 and a Professor in 2021 with Tokyo Metropolitan University. His current research interests include gate-drive circuits, electromagnetic interference filters, and a power converter circuit. Prof. Wada is a Senior Member of IEEE.



**Rudy Wang** | Sr. Member of the R&D Staff

Rudy Wang received the B.S. and M.S. degrees in electrical engineering from Xi'an Jiaotong University, Xi'an, China, and the Ph.D. degree from the Center for Power Electronics Systems (CPES), Virginia Tech, Blacksburg, VA, USA, in 2004, 2007, and 2012, respectively.

After graduation, he joined the General Electric company first at GE Global Research and then at GE Aviation. He was senior staff engineer and project leader on projects including electrification in transportation, healthcare electronics, renewable energy, industrial solutions, etc. In 2020, he joined the Milan M. Jovanovic Power Electronics Lab of Delta Electronics (Americas) Ltd. He received the third and second place William M. Portnoy Award for the Best Paper published in the IEEE Energy Conversion Congress and Exposition (ECCE) in 2012 and 2018. He also received the GE Gold Medal Inventor award in 2019. Since 2015, he has been an Associate Editor of the IEEE Transaction on Industrial Applications. From 2015 to 2019, he was the Chair of the Power Electronics Devices and Components Committee in IEEE Industry Applications Society.

He has published more than 50 papers in refereed journals and international conference proceedings and more than 25 awarded or pending US patents. His research and development interests include electric circuit and topologies, wide-band gap device-based converter design, high power density and harsh environment power electronics, electromagnetic interference technology, etc. His current focus in Delta is in medium voltage fast EV charging and other relevant applications.





**Ahmed Yago** is an electrical engineer II with Crane Aerospace and Electronics in Fort Walton Beach, Florida. Previously he has worked as product electrical engineer II with BorgWarner. He received his Master's degree in Electrical and Computer Engineering with primary focus on Power Electronics and Control System, his Bachelor's degree is in electrical and computer Engineering from Purdue University, IUPUI campus, respectively 2021 and 2019.

He is currently on pursuing a PhD in Power Electronics with research primarily focused on High power, and covers the following; performing design and development of power supplies, research into the development/design of bidirectional DC-DC power converter for electric vehicles, conducting technical analysis to validate designs and performing functional, acceptance, qualification or development testing on new or modified designs. Ahmed has authored few researches papers on wireless power transfer and computer power supply.



**Gary Yao** got his Ph.D. degree from Virginia Tech in 2004. He had over 20 years' industry experience, worked at MPS, Volterra and Fairchild before. Currently he is working at Silergy Technology at Silicon Valley Bay Area as a Chief System Architect.

He published over 40 IEEE conference and transaction papers and is the inventor for over 30 patents. Currently he is leading the company's research and development work.



**Richard Zhang** received his B.S. and M.S. degrees in electrical engineering from Tsinghua University in 1989 and 1993, respectively, and his Ph.D. degree in electrical engineering from Virginia Tech in 1998. Dr. Zhang is the former Chief Technology Officer of GE's Grid Integration Solutions a \$1B business focusing on High Voltage DC Transmission and Flexible AC Transmission Systems (HVDC & FACTS). Prior to joining Virginia Tech in 2021, Dr. Zhang was an Executive leader holding various technology and business leadership positions during his 22 years of career with GE in various GE organizations, such as GE Global Research Center, GE Oil & Gas, GE Power Conversion, GE Renewables, and GE Energy Connection.

During 1998-2008, Dr. Zhang led power electronics research at GE Global Research Center serving all GE industrial businesses, including GE Oil & Gas, GE Aviation, GE Renewables, GE Power, GE Healthcare, GE Transportation, GE Lighting, GE Appliance, and GE Industrial Systems, as well as working with government agencies, such as DARPA (Defense Advanced Research Projects Agency), ONR (Office of Naval Research), and DOE (Department Energy), to advance the frontier of power electronics technologies. From 2008 to 2016, Dr. Zhang led power electronics, rotating machine, and automation technologies in GE Oil & Gas, GE Power Conversion, GE Renewables, GE Energy Connection, and GE Grid Integration Solutions, based in France, China, and the UK. He led diverse global teams with more than 600 people that span 22 sites in 9 different countries (US, Canada, UK, France, Germany, Finland, China, India, Brazil). Most recently, the advanced HVDC valve and HVDC control technology that Dr. Zhang led resulted in GE winning the 1.4 GW HVDC project in the North Sea in the UK – the world's largest and longest distance offshore HVDC project for offshore wind farm tie-back. Richard served as Chairman of Industrial Advisory Board for CPES at Virginia Tech; served as Chairman, Board of Directors for Powerex - a power semiconductor and packaging company in the US; served as a steering committee member for SuperGrid Institute SAS in France; and served as an AdCom member for IEEE Power Electronics Society. Dr. Zhang has 47 journal and conference publications and invited talks, including 4 IEEE Transaction Award Papers. Dr. Zhang has over 105 global patents granted or pending in 42 patent families. Dr. Zhang is a Fellow of IEEE for his technical leadership in the development of high-power electronics.





**Yuhao Zhang** received the B.S. degree from Peking University, Beijing, China, in 2011, and the M. S. and Ph. D. degrees in electrical engineering from Massachusetts Institute of Technology (MIT), Cambridge, MA, USA, in 2013 and 2017, respectively. From 2017 to 2018, he was a Postdoctoral Associate with MIT. Since 2018, he has been an Assistant Professor with the Center for Power Electronics Systems, the Bradley Department of Electrical and Computer Engineering, Virginia Tech., Blacksburg, VA, USA.

He has authored or coauthored more than 100 journal articles and conference proceedings and is an inventor of 5 granted U. S. patents. His research interests include power semiconductor devices, (ultra-)wide-bandgap semiconductor materials, power electronics applications, and machine learning assisted co-design. Dr. Zhang is the recipient of the 2017 MIT Microsystems Technologies Laboratory Doctoral Dissertation Seminar Award, 2019 IEEE George Smith Award, 2021 National Science Foundation CAREER Award, as well as 2021 Outstanding Assistant Professor Award and 2022 Faculty Fellow Award of Virginia Tech Engineering.

CPES is among the largest academic research centers in the world. More than 100 researchers, graduate students, visiting scholars, and staff work full-time in Blacksburg and Arlington, Virginia, to fulfill our mission of providing leadership through global collaborative research and education in creating advanced electric power processing systems of the highest impact to society.

To support these efforts, CPES boasts more than 22,000 ft<sup>2</sup> of state-of-the-art laboratories and instrumentation in Blacksburg, VA, on the main campus of Virginia Tech and in Arlington, VA, in the Washington, D.C., metropolitan area.

Both Blacksburg and Arlington sites feature fully equipped laboratories for integrated packaging and electrical research including ever-increasing capabilities in high-power research.

## GREATER WASHINGTON, D.C., AREA

The CPES labs in the greater Washington, D.C., metropolitan area is a showcase facility for Virginia Tech and is well-suited to continue building upon CPES's internationally recognized expertise in developing groundbreaking power electronics technologies. Located in the Virginia Tech Research Center-Arlington, the power electronics lab opened in 2018 and is equipped with the latest testing and measurement equipment capable of achieving several hundreds of kilowatts of power. The packaging laboratory is equipped with state-of-the-art equipment for designing, building, characterizing, and testing advanced power electronics packages. The power electronics lab will be renovated and expanded in 2023 to increase our efforts in electrified green infrastructure power conversion technologies. This will include adding five more benches and extending the test bay area to enable grid simulation and grid-level research.

## ELECTRICAL RESEARCH LABORATORIES

The electrical research laboratory is equipped with state-of-the-art tools and equipment for development of power electronic circuits and systems of all sizes, from sub-volts, sub-watts to 30 kV, 2 MW. It also includes an EMI chamber, and a mechanical shop. To support our students building and testing hardware, each student bench features more than \$50,000 of instrumentation.

Standard instrumentation includes GHz oscilloscopes, multi-channel function generators, electronic loads, low- and high-voltage passive and differential probes, network, spectrum,

impedance, logic, and power analyzers, thermal sensors, and ac-dc bench supplies of all sizes. Specialized test room equipment includes thermal imaging, Hi-Pot testers for Partial Discharge Measurement, an EMI/EMC analyzer, large dynamometers, automatic circuit board routing equipment, magnetic core loss testing, programmable and variable loads, and a liquid-cooled heat exchanger.

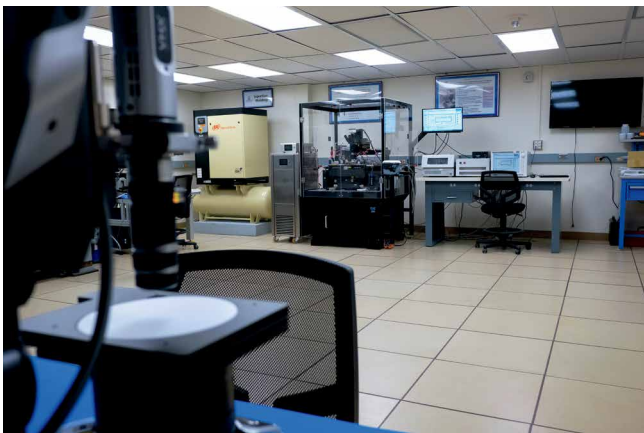
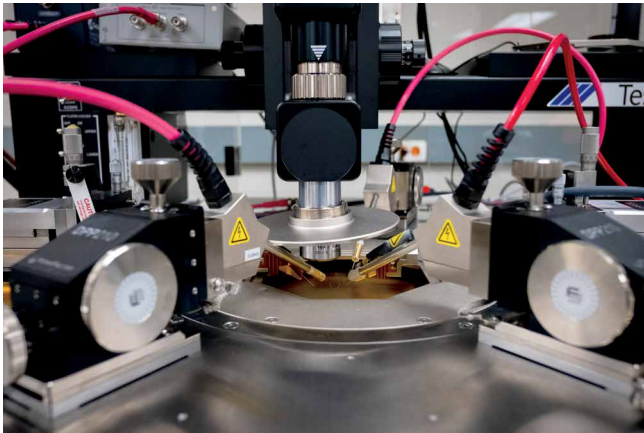
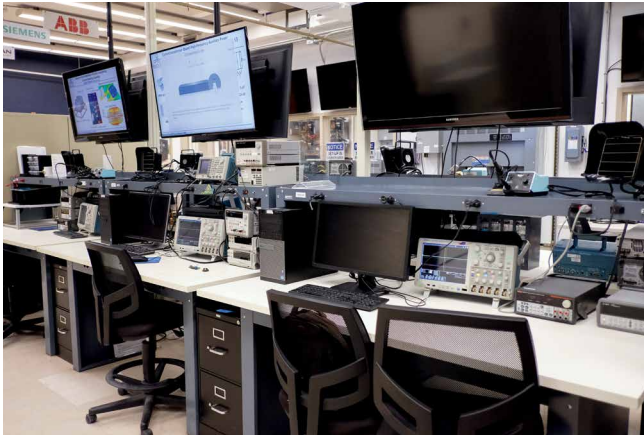
## INTEGRATED PACKAGING LABORATORIES

The Integrated Packaging Lab was established in 1998 using funds from the NSF ERC grant to create and evaluate alternative approaches to the design and manufacture of Integrated Power Electronics Modules (IPEMs). In 2022, a packaging lab extension was completed in our Arlington facility. Both labs contain advanced electronic manufacturing and assembly equipment. As a whole it has the capability to produce and develop substrate patterns by virtue of laser ablation machining, chemical metal etching, and screen printing. 3D printers are found in both labs to facilitate housing production of packaged converters. Shared lab facilities with the Department of Electrical and Computer Engineering in Blacksburg gives access to RF sputtering and full clean room processes for wafer design.

The Integrated Packaging Labs also have the ability to mount bare dies using silver sintering technology and SMT components using a solder reflow belt furnace and convection reflow oven. Device attachment reliability is tested with multi-purpose bond-testing equipment found in both locations.

State-of-the-art device characterization equipment can also be found in the Blacksburg Integrated Packaging Lab. This includes a Keysight B1505A curve tracer that is rated at 10 kV and 1500 A, a Form Factor probe station with a gold thermal chuck, and ATT system's thermal controller/chiller to give the ability to test bare die from -30 °C to 300 °C.

The wire bonding machines equipped in both labs provide interconnect options of heavy aluminum wire bonding, gold wire ball bonding, and aluminum/gold ribbon bonding for manufacturing modules. The module-level test and evaluation of electrical, thermal, and reliability performance for the assembled modules are also available in the Integrated Packaging Labs. Thermal analysis equipment is found in our Arlington Integrated Packaging Lab.

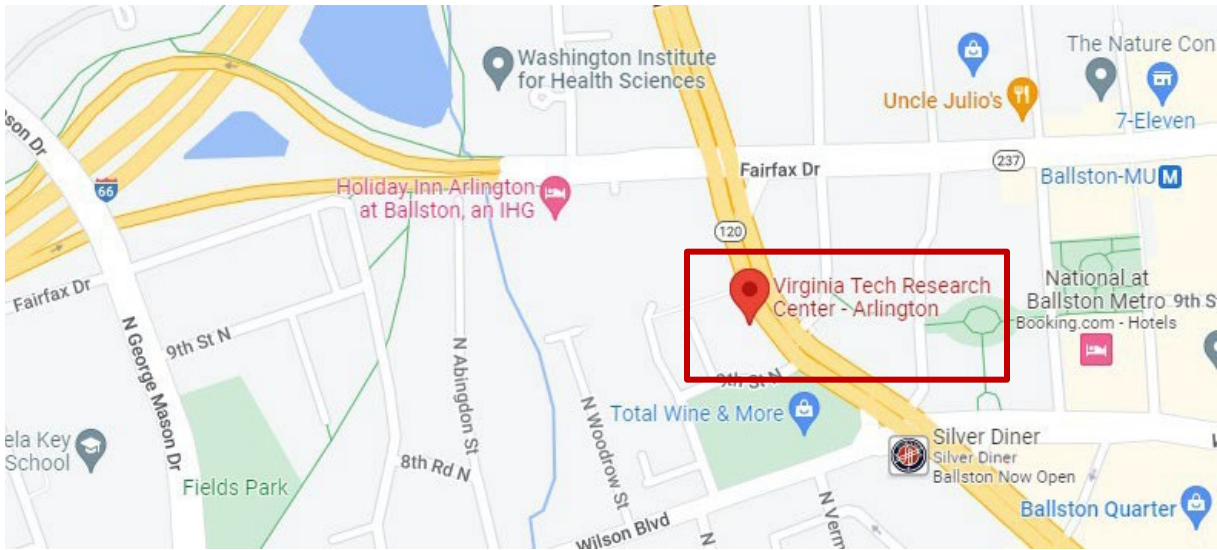



## LAB FEATURES

- High-performance computing for advanced simulations
- Access to state-of-the-art simulation software
- Isolated test bays for remote high-power testing
- Mechanical shop to facilitate prototype manufacturing
- Numerous high-power ac and dc supplies
- 24 kV DC 2 MW MMC converter test bed
- Partial discharge detection equipment
- EMI chamber
- IsoVu probes
- Power hardware in the loop solution
- Impedance measurement units
- 10 kV curve tracer with wafer probing station
- 3D printing
- Semiconductor packaging and integration
- Flip chip die bonding
- Thermal impedance measurements
- Bond shear and pull testing
- Digital microscopes
- Thermal and active power cycling

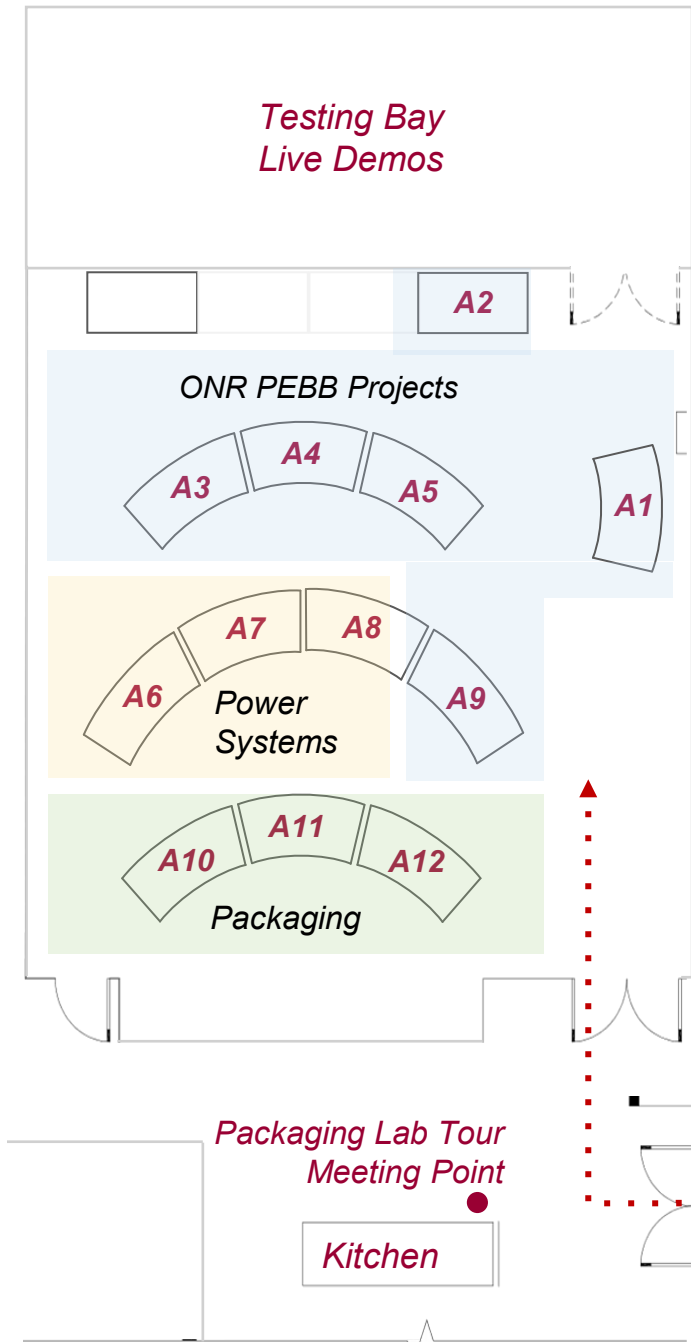
*Scan for more information about CPES facilities.*



<b>Location</b>	Virginia Tech Research Center – Arlington 900 N Glebe Rd, Arlington, VA 22203, United States	
		
<b>Parking</b>	A parking garage is located beneath the Virginia Tech Research Center (900 N. Glebe Road). The garage entrance is off 9th St N at the corner of Glebe Road. 	
<b>Directions</b>	For arriving by metro or bus - <a href="https://dcaea.vt.edu/discovery/research-center-arlington.html">https://dcaea.vt.edu/discovery/research-center-arlington.html</a> .	

**CPES 4<sup>th</sup> Floor Electronics Lab**

**Poster and Projects**



**A1** – [T3.1]: Noise Propagation Study on Gate Drivers Caused by Near Field Coupling Inside Power Converters, He Song

**A2** – [P5.9]: Multi-Objective Co-Design of an Integrated Power Electronics Building Blocks, Marie Lawson

**A3** – [P2.7]: Electro-Thermal Analysis and Packaging of Organic Substrate-Based Power Module, Narayan Rajagopal

**A4** – [P5.10]: Gate Driver Integrated Sensors, Vladimir Mitrovic

**A5** – [P4.10]: Weight-Optimized Design of Modular Converter-Based Power & Energy Systems, Qian Li

**A6** – [P4.1]: Power Conversion Solution for Hydrogen Production, Shivani Nair

**A7** – [P4.2]: Offshore Wind Integration Through HVDC, Jiaxiong Yu

**A8** – [P5.1]: Microgrid Building Blocks, Haris Bin Ashraf

**A9** – [T3.3]: EMI Mitigation for SiC MOSFET Power Modules Using Integrated CM Screen, Taha Moaz

**A10** – [P1.14]: Fabrication Refinement and Evaluation of a Wirebond-less Multi-chip Power Modules, Danielle Lester

**A11** – [P1.8]: Accurate and Repeatable Measurement of the  $R_{TH,JC}$  of SiC Package, Jack Knoll

**A12** – [P1.12]: Electro-Thermal Device-Package Co-Design for Gallium Oxide Power Devices, Benjamin Lyon

**CPES 5<sup>th</sup> Floor Packaging Lab Tour:**

Tour 1: 10:00 am ET

Tour 2: 10:30 am ET

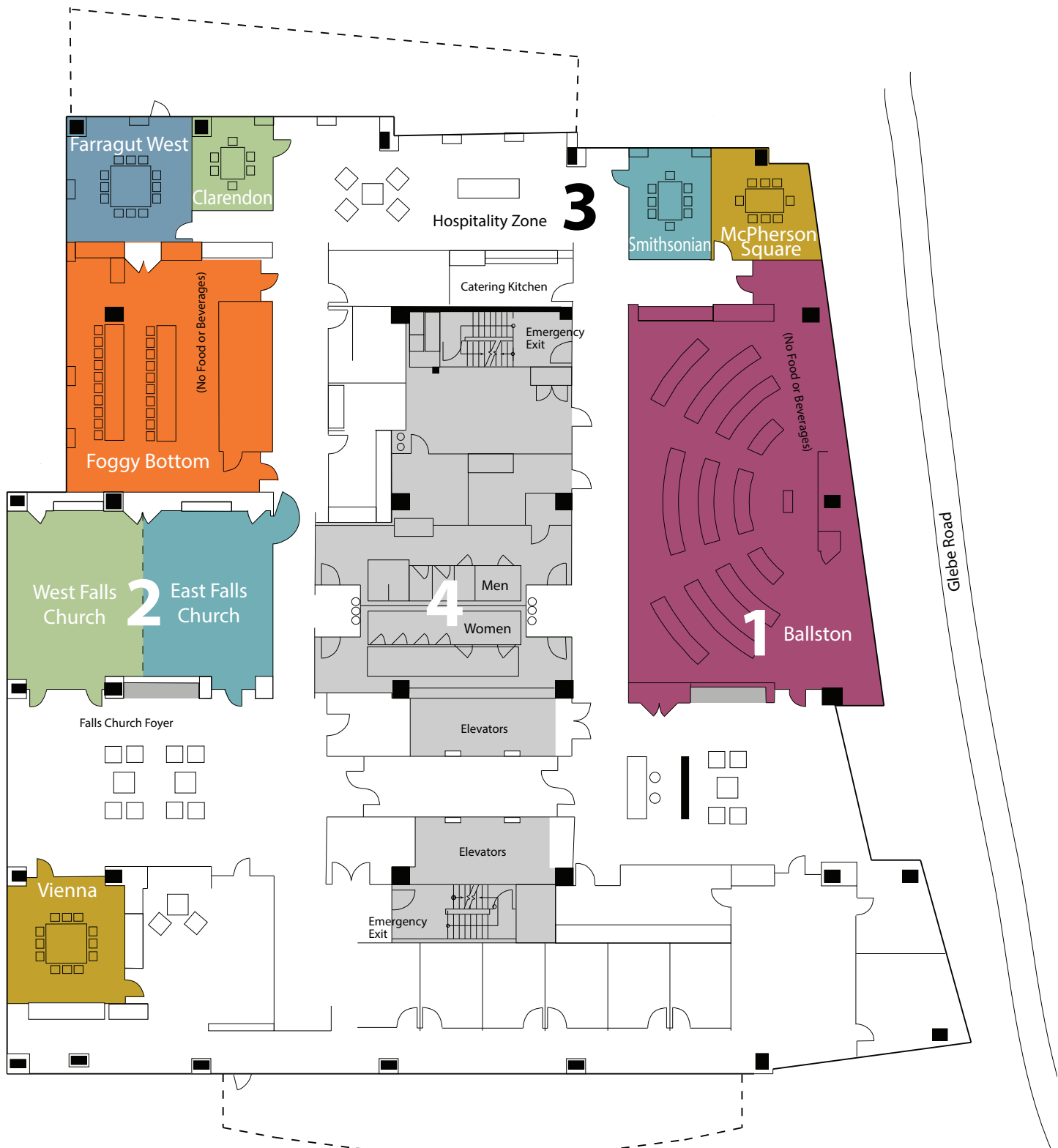
Tour 3: 10:45 am ET

**Testing Bay Lab Demos:**

Microgrids Building Block (MBB)

Power Electronics Building Block (PEBB)





1. Ballston – Plenary Sessions; Breakout Room if needed
2. West/East Falls Church – Breakout Sessions
3. Hospitality Zone – Coffee, Refreshments, and Lunch
4. Women/Men - Restrooms